L Number	Hits	Search Text	DB	Time stamp
10	3639	mirror$2 with wafer	USPAT	2002/11/17 18:50
11	973	(mirror$2 with wafer) and photoresist	USPAT	2002/11/17 18:52
12	342	((mirror$2 with wafer) and photoresist) and (cut$3 or singulat$3 or slice or dice or saw)	USPAT	2002/11/17 18:54
13	177	(((mirror$2 with wafer) and photoresist) and (cut$3 or singulat$3 or slice or dice or saw)) and (chip or die)	USPAT	2002/11/17 19:33
14	0	6407844.URPN.	USPAT	2002/11/17 19:03
15	0	6407844.URPN.	USPAT	2002/11/17 19:04
16	11	("4942766" | "5488862" | "5548618" | "5629790" | "5658710" | "5841553" | "5861549" | "5969465" | "6064779" | "6123985" | "6175443").PN.	USPAT	2002/11/17 19:04
17	3	5668062.URPN.	USPAT	2002/11/17 19:24
18	15	("3537169" | "3677875" | "4455739" | "4542397" | "5061049" | "5079544" | "5105369" | "5182233" | "5278652" | "5341024" | "5393706" | "5435876" | "5501104" | "5527744" | "5534102").PN.	USPAT	2002/11/17 19:24
23	71	((chip or die) near mirror$2) and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/17 19:41
24	51	438/460.ccls. and mirror	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/17 19:42
25	58	438/460.ccls. and mirror$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/17 19:59
26	2	6335224.URPN.	USPAT	2002/11/17 19:50
27	115	(dmd) and (chip or dier) and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/17 20:00
28	136	(dmd) and (chip or die) and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/17 20:00